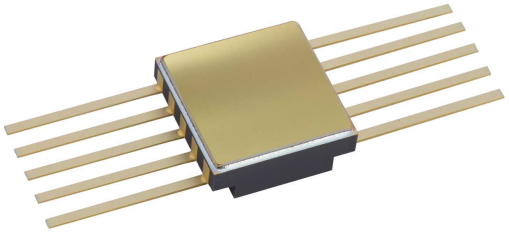
# RHF1009A

## Rad-hard adjustable 2.5 V/5.5 V precision shunt V-ref

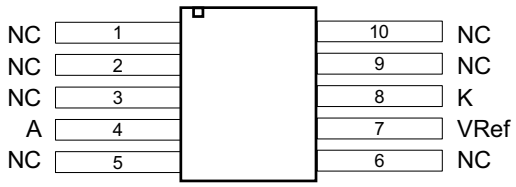
**Datasheet - production data**



**Ceramic Flat-10**

The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package

Pin connections
(top view)




## Features

- Adjustable shunt, 2.5 V to 5.5 V
- High precision ±0.2% at 2.5 V at 25 °C
- Wide operating current: 60 µA to 12 mA
- 30 ppm/°C maximum temperature range at 2.5 V
- Stable on capacitive load
- ELDRS-free up to 300 krad
- 300 krad high/low dose rate
- SEL-free up to 120 MeV.cm²/mg
- SET characterized
- Mass = 0.50 g
- SMD: 5962F14222

## Applications

- Space systems
- Space data acquisition systems
- Aerospace instrumentation
- ADC references

## Description

The RHF1009A is a low-power adjustable 2.5 V voltage reference, specifically designed to sustain radiations in space applications.

Mounted in a Flat-10 ceramic package, the RHF1009A uses a dedicated architecture and design rules to provide the best immunity against heavy-ions.

A very low operating current and very good stability over a wide temperature range of -55 °C to +125 °C make the RHF1009A particularly suitable for precision and power saving.



This is information on a product in full production. www.st.com

# Contents


1 **Absolute maximum ratings and operating conditions . . . . . 3**

2 **Electrical characteristics . . . . . 4**

3 **Radiation . . . . . 6**

4 **Design information . . . . . 11**

4.1 Introduction . . . . . 11

4.2 Average temperature coefficient . . . . . 11

4.3 Minimum and maximum cathode current . . . . . 12

4.3.1 Minimum operating cathode current . . . . . 12

4.3.2 Maximum operating cathode current (Ikmax.) . . . . . 12

4.4 Capacitive load considerations . . . . . 12

5 **Package information . . . . . 13**

5.1 Ceramic Flat-10 package information . . . . . 14

6 **Ordering information . . . . . 15**

7 **Other information . . . . . 16**

7.1 Date code . . . . . 16

7.2 Product documentation . . . . . 17

8 **Revision history . . . . . 18**

# 1 Absolute maximum ratings and operating conditions

**Table 1. Absolute maximum ratings**

| Symbol | Parameter | Value | Unit |
|---|---|---|---|
| $I_K$ | Reverse breakdown current | 15 | mA |
| $I_F$ | Forward current | 20 | mA |
| $V_{KA}$ | Reverse breakdown voltage in standby mode ($V_{Ref} = V_A$) | 6 | V |
| $T_{stg}$ | Storage temperature | -65 to +150 | °C |
| $T_j$ | Maximum junction temperature | 150 | °C |
| $R_{thja}$ | Thermal resistance junction ($T_j$) to ambient ($T_{amb}$) | 140 | °C/W |
| $R_{thjc}$ | Thermal resistance junction to case | 40 | °C/W |
| ESD | HBM: human body model (1) | 2 | kV |
| | MM: machine model (2) | 200 | V |
| | CDM: charged device model (3) | 1.5 | kV |

1. Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 kΩ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are left floating.
2. This is a minimum value.
   Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins are left floating.
3. Charged device model: all pins and package are charged together to the specified voltage and then discharged directly to ground through only one pin.

**Table 2. Operating conditions**

| Symbol | Parameter | Value | Unit |
|---|---|---|---|
| $I_{Kmin}$ | Minimum operating current<br>[$V_K \geq V_K$ ($I_K$ = 100 µA, Ta = 25 °C) - 100 µV]<br>$V_K = V_{Ref}$ | 60 | µA |
| $V_{KA}$ | Reverse breakdown voltage<br>in operating mode:<br>in standby mode ($V_{Ref} = V_A$): | <br>2.5 to 5.5<br>2.5 to 5.5 | V |
| $I_{Kmax}$ | Maximum operating current<br>[$V_K \geq V_K$ ($I_K$ = 100 µA, Ta = 25 °C) + 2 mV]<br>$V_K = V_{Ref}$ | 12 | mA |
| $T_{oper}$ | Operating ambient temperature range | -55 to +125 | °C |

# 2 Electrical characteristics

Parameters tested before radiation are shown in *Table 3*.

**Table 3. Anode is connected to Gnd (0 V), $V_K$ is in reference to anode voltage. $C_K$ (between anode and cathode) = 100 nF, $R_1$ = 0 and $R_2$ not connected unless otherwise specified**

| Symbol | Parameter | Test conditions | Temp. | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|---|
| **DC performance** | | | | | | | |
| $V_{Ref}$ | Reference input voltage | $I_K$ = 100 µA<br>$V_K = V_{Ref}$ | +25 °C | | 2.5 | | V |
| $\Delta V_{Ref}$ | Reference input voltage tolerance | $I_K$ = 100 µA<br>$V_K = V_{Ref}$ | +25 °C | -5 | | +5 | mV |
| $I_{Kmin}$ | Minimum operating current | [$V_K \geq V_K$ ($I_K$ = 100 µA, Ta = 25°C) - 100 µV]<br>$V_K = V_{Ref}$ | -55 °C<br>+25 °C<br>+125 °C | | | 60<br>60<br>60 | µA |
| $I_{Koff}$ | Off state cathode current | $V_{Ref} = V_A$<br>$V_{KA}$ = 2.5V | -55 °C<br>+25 °C<br>+125 °C | | | 1<br>1<br>1 | µA |
| $I_{Ref}$ | Reference input current | $I_K$ = 100 µA to 10 mA<br>$V_K = V_{Ref}$ on $R_1$ = 10 kΩ | -55 °C<br>+25 °C<br>+125 °C | | | 1<br>1<br>1 | µA |
| $\Delta V_{Ref}/\Delta T$ | Average temperature coefficient $\frac{VRefmax - VRefmin}{180°C \times VRef(25°C)} \times 10^6$ | $I_K$ = 100 µA<br>$V_K = V_{Ref}$ | -55 °C<br>to<br>+125 °C | | | 30 | ppm/°C |
| | | $I_K$ = 10 mA<br>$V_K = V_{Ref}$ | -55 °C<br>to<br>+125 °C | | | 30 | |
| $\Delta V_{Ref}/\Delta V_{KA}$ | Reference voltage versus cathode voltage variation | $I_K$ = 100 µA<br>$V_{KA}$ = 2.5 V to 5.5 V<br>$R_1$ = 10 kΩ, $R_2$Variable | -55 °C<br>to<br>+125 °C | | 1.5 | 2.5 | mV/V |
| | | $I_K$ = 10 mA<br>$V_{KA}$ = 2.5 V to 5.5 V<br>$R_1$ = 10 kΩ, $R_2$Variable | -55 °C<br>to<br>+125 °C | | 1.5 | 2.5 | |
| $\Delta V_{Ref}/\Delta I_K$ | Reference voltage versus cathode current variation | $I_{Kmin} \leq I_K \leq$ 1 mA<br>$V_K = V_{Ref}$ | -55 °C<br>+25 °C<br>+125 °C | | 0.075<br>0.08<br>0.15 | 0.15<br>0.16<br>0.3 | mV |
| | | 1 mA $\leq I_K \leq$ 12 mA<br>$V_K = V_{Ref}$ | -55 °C<br>+25 °C<br>+125 °C | | 0.65<br>0.7<br>1 | 1.3<br>1.4<br>2 | |
| $R_{KA}$ | Reverse static impedance | $\Delta I_K = I_{Kmin}$ to 10 mA<br>$V_K = V_{Ref}$ | -55 °C<br>+25 °C<br>+125 °C | | 0.05<br>0.06<br>0.1 | 0.1<br>0.12<br>0.2 | Ω |
| $Z_{KA}$ | Reverse dynamic impedance | $I_K$ = 1 mA to 1.1 mA<br>$V_K = V_{Ref}$, F ≤ 1 kHz<br>No capacitive load | -55 °C<br>+25 °C<br>+125 °C | | 0.4<br>0.4<br>0.5 | | Ω |

**Table 3. Anode is connected to Gnd (0 V), $V_K$ is in reference to anode voltage. $C_K$ (between anode and cathode) = 100 nF, $R_1$ = 0 and $R_2$ not connected unless otherwise specified (continued)**

| Symbol | Parameter | Test conditions | Temp. | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|---|
| Kvh(1) | Long-term stability<br>$\frac{\lvert Vk(0hr) - Vk(1000hrs)\rvert}{Vk(0hr)} \times 10^6$ | $I_K$ = 100 µA<br>$V_K = V_{Ref}$<br>t = 1000 hrs | -55 °C<br>+25 °C<br>+125 °C | | 100<br>100<br>100 | | ppm |
| Kvhd | Stability in radiation<br>$\frac{\lvert Vk(0rad) - Vk(300krad)\rvert}{Vk(0rad)} \times 10^6$ | $I_K$ = 100 µA<br>$V_K = V_{Ref}$<br>Total dose = 300 krad<br>Dose rate = 0.01 rad/s | -55 °C<br>+25 °C<br>+125 °C | | 1000<br>1000<br>1000 | | ppm |
| en | Voltage noise | $I_K$ = 100 µA<br>$V_K = V_{Ref}$<br>F= 1 kHz | -55 °C<br>+25 °C<br>+125 °C | | 760<br>880<br>980 | | nV/<br>√ Hz |

1. Reliability verified with a cathode current setting $I_K$ = 10 mA

# 3 Radiation

### Total ionizing dose (MIL-STD-883 TM 1019)

The products guaranteed for radiation within the RHA QML-V system fully comply with the MIL-STD-883 TM 1019 specification.

The RHF1009A is RHA QML-V, tested and characterized in full compliance with the MIL-STD-883 specification, both below 10 mrad/s and between 50 and 300 rad/s, as follows:

- All tests are performed in accordance with MIL-PRF-38535 and the test method 1019 of MIL-STD-883 for total ionizing dose (TID).
- The ELDRS characterization is performed in qualification only on both biased and unbiased parts, on a sample of ten units from two different wafer lots.
- Each wafer lot is tested at high-dose rate only, in the worst bias case condition, based on the results obtained during the initial qualification.

### Heavy-ions

The behavior of the product when submitted to heavy-ions is not tested in production. Heavy- ion trials are performed on qualification lots only.

**Table 4. Radiations**

| Type | Characteristics | Value | Unit |
|---|---|---|---|
| TID | 180 krad/h high-dose rate (50 rad/s) up to: | 300 | krad |
| | ELDRS-free up to: | 300 | |
| | 36 rad/h low-dose rate (0.01 rad/s) up to: | 300 | |
| Heavy-ions | SEL immunity up to:<br>(at 125 °C, with a particle angle of 60 °) | 120 | MeV.cm²/mg |
| | SEL immunity up to:<br>(at 125 °C, with a particle angle of 0 °) | 60 | |
| | SET (at 25 °C) | Characterized | |

*Note: In Figure 1 to 24, temp. = temperature, freq. = frequency, and resp. = response.*

**Figure 1. Reverse breakdown voltage characteristics vs. cathode current**

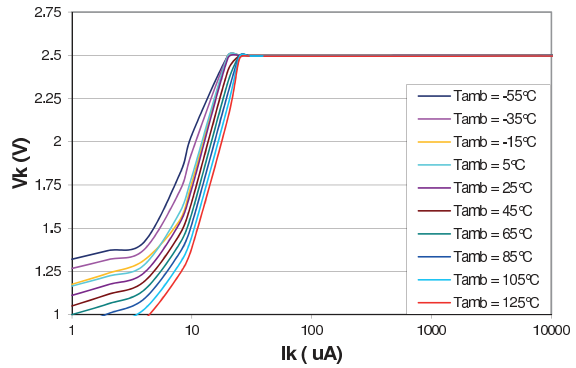



**Figure 2. Zoom of reverse breakdown voltage characteristics vs. cathode current**

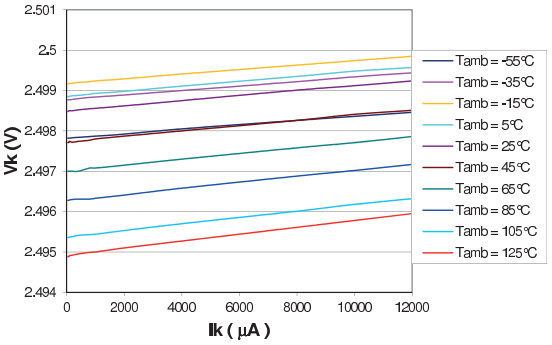



**Figure 3. Reverse breakdown voltage characteristics vs. ambient temp.**

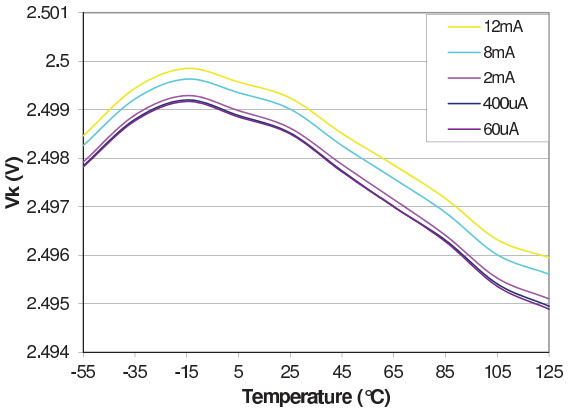



**Figure 4. Average temp. coefficient vs. cathode current**

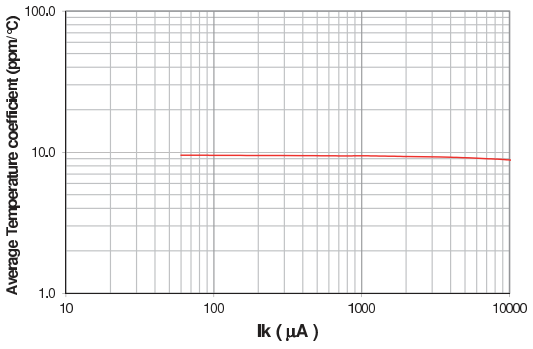



**Figure 5. Output impedance vs. freq. at +125 °C, $C_k$ = 47 nF**

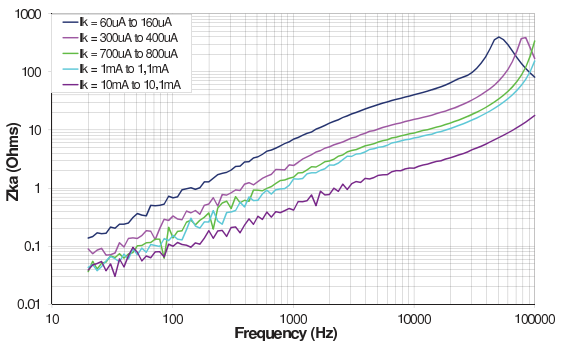



**Figure 6. Output impedance vs. freq. at 125 °C, $C_k$ = 100 nF**

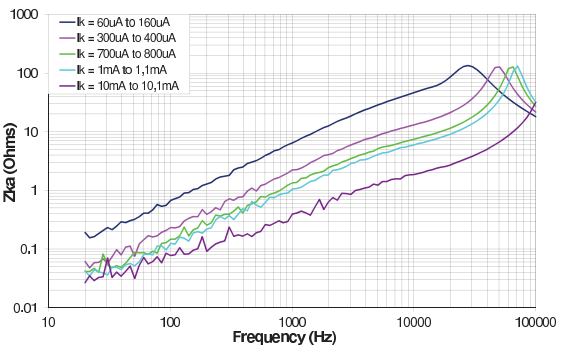


**Figure 7. Output impedance vs. freq. at +25 °C, $C_k$ = 47 nF**

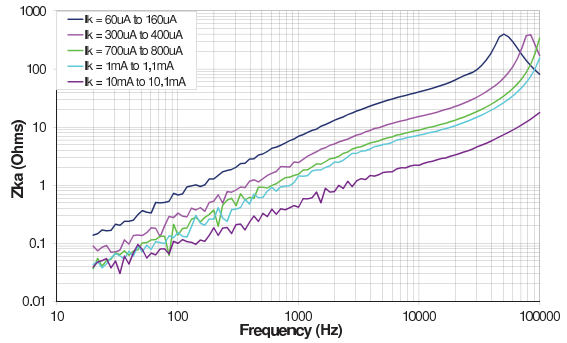



**Figure 8. Output impedance vs. freq. at 25 °C, $C_k$ = 100 nF**

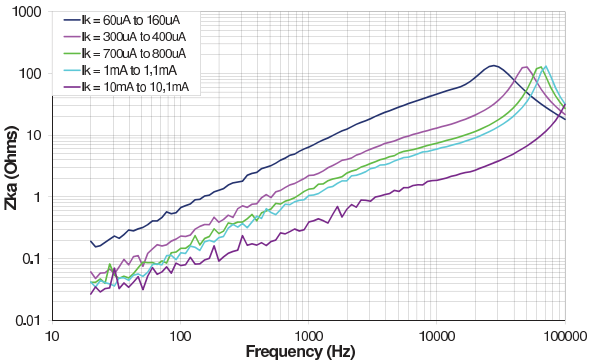



**Figure 9. Output impedance vs. freq. at -55 °C, $C_k$ = 47 nF**

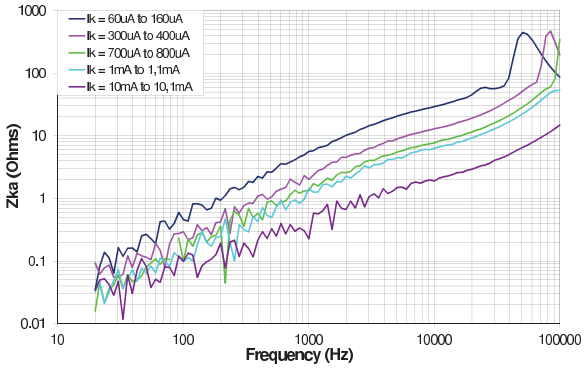



**Figure 10. Output impedance vs. freq. at -55 °C, $C_k$ = 100 nF**

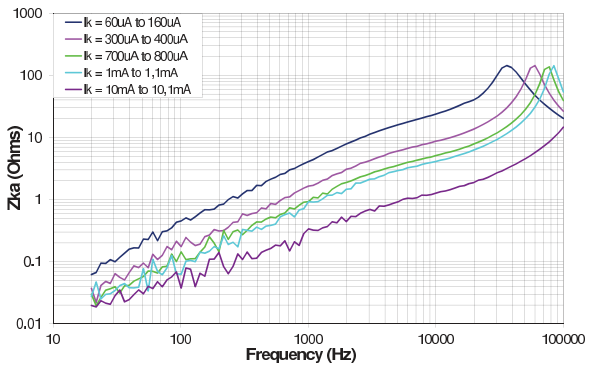



**Figure 11. Output impedance vs. freq. at +125 °C, $C_k$ = 470 nF**

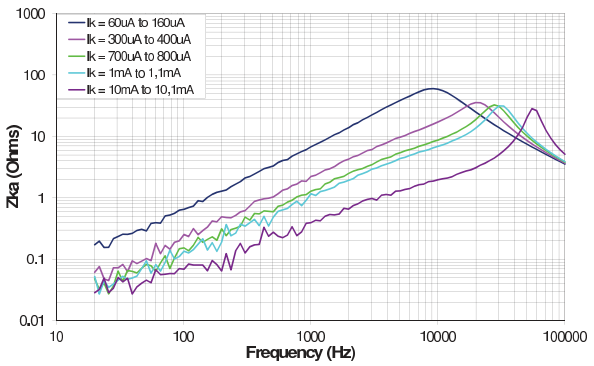



**Figure 12. Output impedance vs. freq. at +125 °C, $C_k$ = 1 µF**

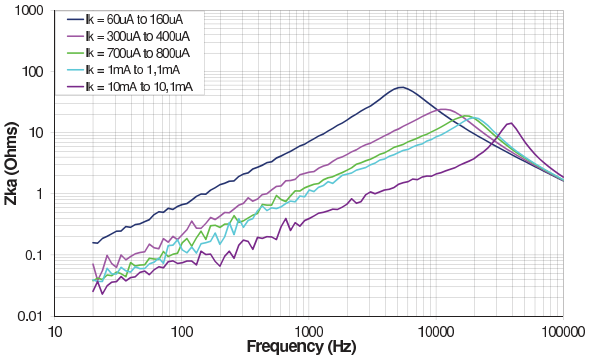


**Figure 13. Output impedance vs. freq. at +25 °C, $C_k$ = 470 nF**

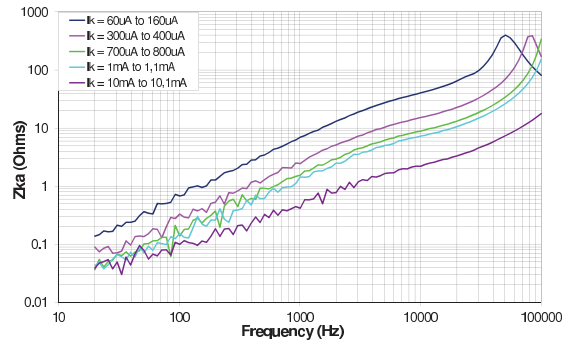



**Figure 14. Output impedance vs. freq. at +25 °C, $C_k$ = 1 µF**

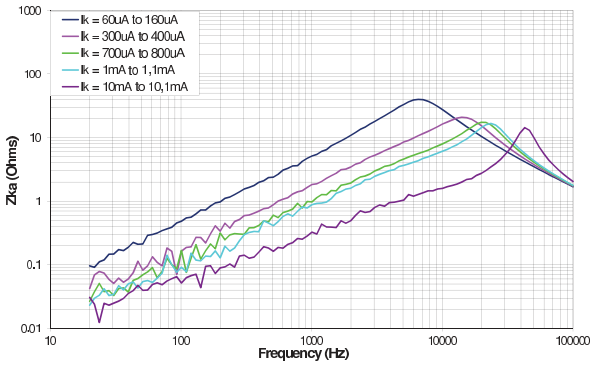



**Figure 15. Output impedance vs. freq. at -55 °C, $C_k$ = 470 nF**

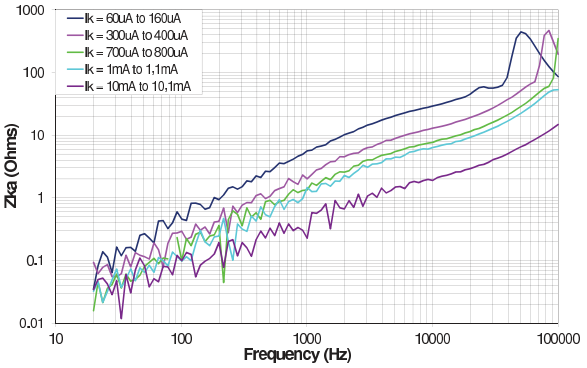



**Figure 16. Output impedance vs. freq. at -55 °C, $C_k$ = 1 µF**

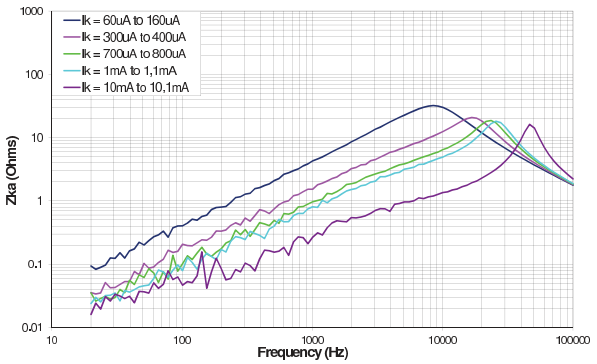



**Figure 17. Spectral noise density vs. freq. at +125 °C, $C_k$ = 100 nF**

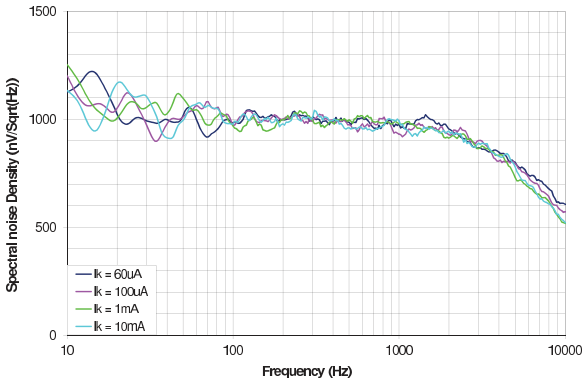



**Figure 18. Spectral noise density vs. freq. at +125 °C, $C_k$ = 1 µF**

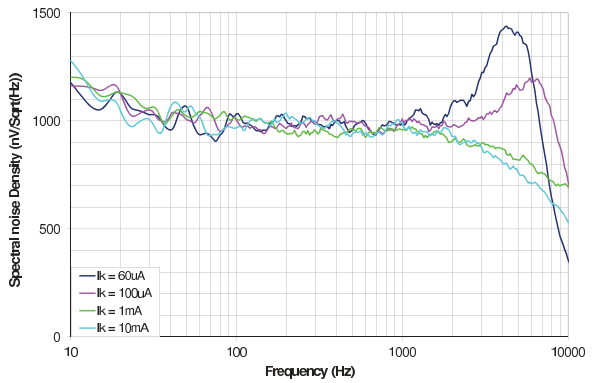


**Figure 19. Spectral noise density vs. freq. at +25 °C, $C_k$ = 100 nF**

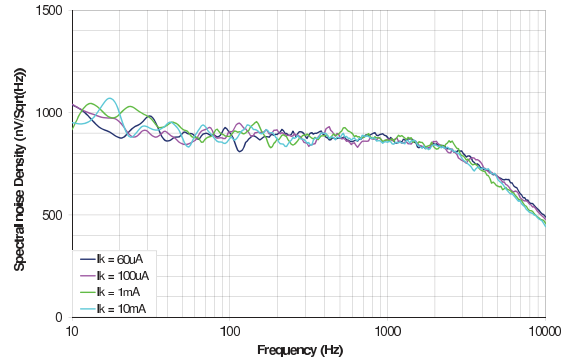



**Figure 20. Spectral noise density vs. freq. at +25 °C, $C_k$ = 1 µF**

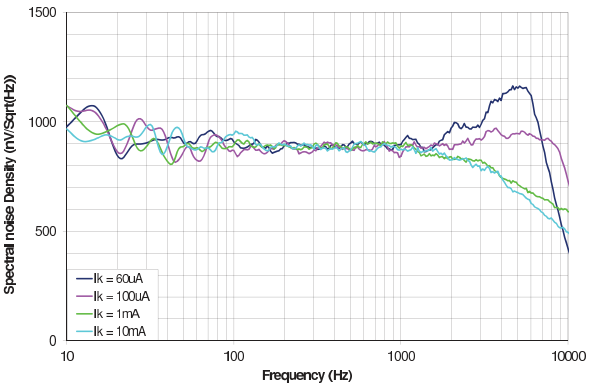



**Figure 21. Spectral noise density vs. freq. at -55 °C, $C_k$ = 100 nF**

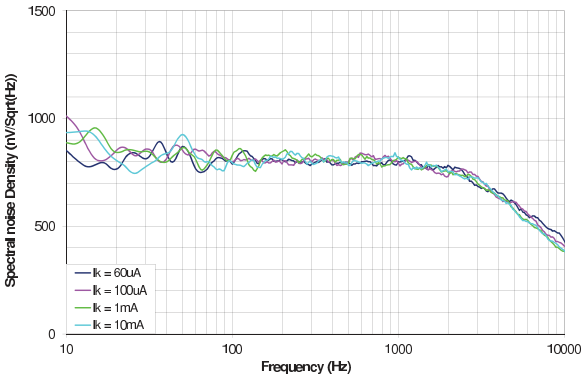



**Figure 22. Spectral noise density vs. freq. at -55 °C, $C_k$ = 1 µF**

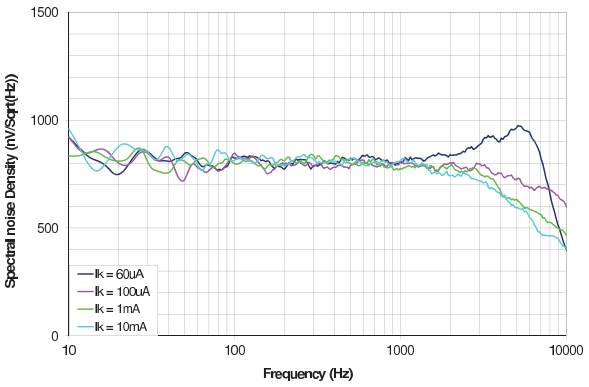



**Figure 23. Low freq. spectral noise density vs. freq. $C_k$ = 100 nF to 1 µF, Ik = 60 µA to 10 mA**

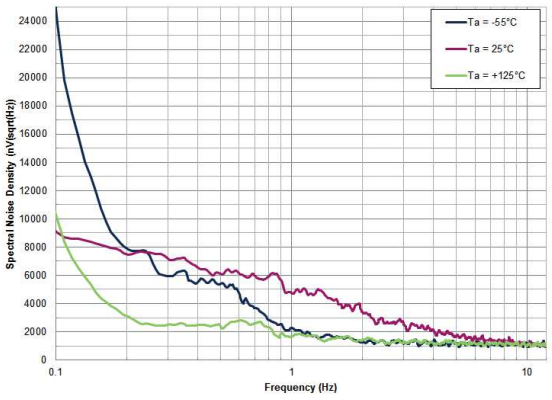
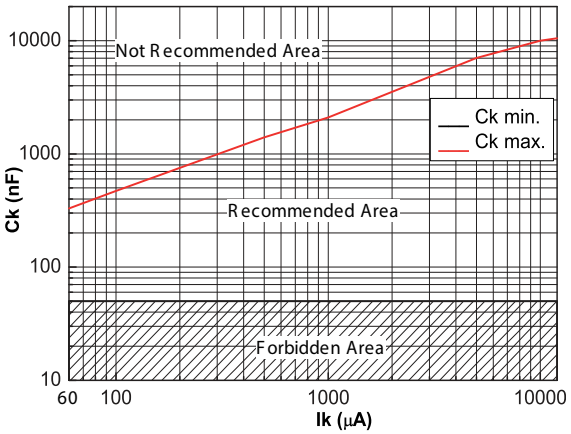



**Figure 24. Recommended operating area**



# 4 Design information

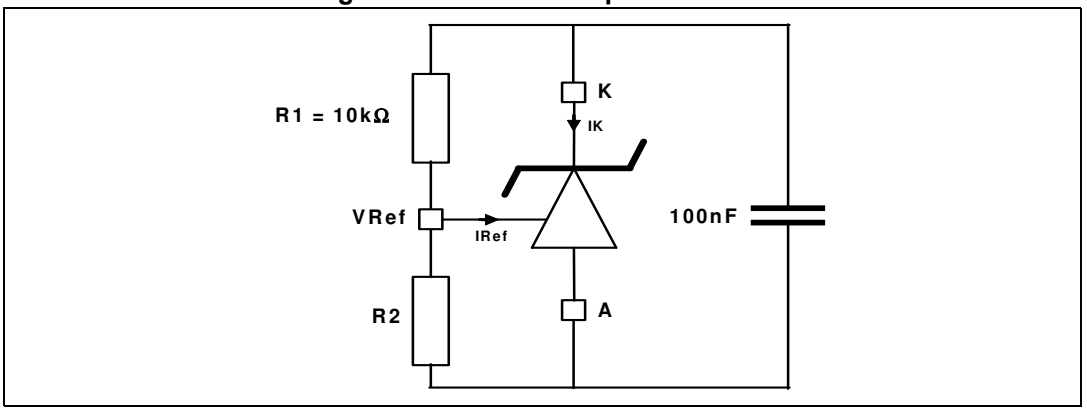
## 4.1 Introduction

The RHF1009A is a programmable voltage reference. It can be set from 2.5 V to 5.5 V by a bridge of 2 resistors (see *Figure 25*).

From -55 °C to +125 °C, the cathode current capability of the RHF1009A ranges from 60 µA up to 12 mA.

Internal double bonding allows the RHF1009A to have an equivalent output resistance as low as 110 mΩ. Consequently, the RHF1009A has very good load regulation.

**Figure 25. Electrical implementation**




$$V_{KA} = V_{Ref} \times \left(1 + \frac{R_1}{R_2}\right) + R_1 \times I_{Ref}$$

## 4.2 Average temperature coefficient

The RHF1009A is designed with a second order compensation in temperature. This gives an S-shaped curve for the $V_k$ variation over the temperature range.

For the RHF1009A, the average temperature coefficient is calculated as shown in *Equation 1*.

**Equation 1**

$$\text{Average temperature coefficient} = \frac{V_{kmax} - V_{kmin}}{(T_{max} - T_{min}) \times v_k(25°C)} \times 10^6$$

where $T_{max}$ = +125 °C and $T_{min}$ = -55 °C.

For each sample, use *Equation 1* and the procedure below:

- Set a cathode current ($I_k$)
- Measure $V_k$ at $I_k$ with an ambient temperature of 25 °C
- Measure $V_k$ at $I_k$ with the following ambient temperatures: -55 °C, -15 °C, +75 °C, and +125 °C.
- For the above five temperature measurements, find the $V_k$ maximum and minimum
- Apply *Equation 1*

The average temperature coefficient is evaluated during product qualification on the above five temperature measurements and is guaranteed on production tests with three temperature measurements: -55 °C, +25 °C, and +125 °C.

## 4.3 Minimum and maximum cathode current

### 4.3.1 Minimum operating cathode current

The minimum operating cathode current ($I_{kmin.}$) is a combination of parameters (such as reference voltage, stability, noise, and process drift) that are taken over the ambient temperature range. For the RHF1009A, $I_{kmin.}$ is 60 µA.

$I_{kmin.}$ is guaranteed over the ambient temperature range by *Equation 2*.

**Equation 2: $V_k(I_k = 60\ \mu A) \geq V_k(I_k = 100\ \mu A, 25\ °C) - 100\ \mu V$**

### 4.3.2 Maximum operating cathode current ($I_{kmax.}$)

The maximum operating cathode current ($I_{kmax.}$) is limited by the output ballast current capabilities and process drift. For the RHF1009A, $I_{kmax.}$ is 12 mA.

$I_{kmax.}$ is guaranteed by the $\Delta V_k$ vs. $\Delta I_k$ parameter (see *Table 3*) and by *Equation 3* (at $T_{amb}$ = 25 °C).

**Equation 3: $V_k(I_k = 12\ mA) \leq V_k(I_k = 100\ \mu A, 25\ °C) + 3\ mV$**

## 4.4 Capacitive load considerations

The RHF1009A can oscillate for a small $I_k$ and no $C_k$. This is why we recommend a minimum capacitive load of 47 nF. The RHF1009A is designed to be stable with a capacitive load ($C_k$) over the cathode current range (60 µA to 12 mA) and ambient temperature range (-55 °C to +125 °C).

If an oscillation amplitude less than 2 mVrms is acceptable, this device can be considered usable with any capacitive load given in *Figure 24: Recommended operating area*.

*Figure 17* to *22* show spectral noise density measurements vs. frequency with a capacitive load of 100 nF and 1 µF. With a capacitive load of 100 nF, all cathode currents are in the "Recommended Area" of *Figure 24* and there is no noise peak in the measured spectral noise density. With a capacitive load of 1 µF, the 60 µA and 100 µA cathode currents are above $C_k$ max in the "Not Recommended Area" of *Figure 24* and there is a noise peak in the measured spectral noise density for these $I_k$. For example, with a capacitive load of 1 µF and $I_k$ = 60 µA, there is a noise peak at about 5000 Hz. For the reverse breakdown voltage ($V_k$), this peaking corresponds to a micro-oscillation, with jitter, centered at 5000 Hz.

# 5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions, and product status are available at: www.st.com.
ECOPACK is an ST trademark.

## 5.1 Ceramic Flat-10 package information

**Figure 26. Ceramic Flat-10 package outline**

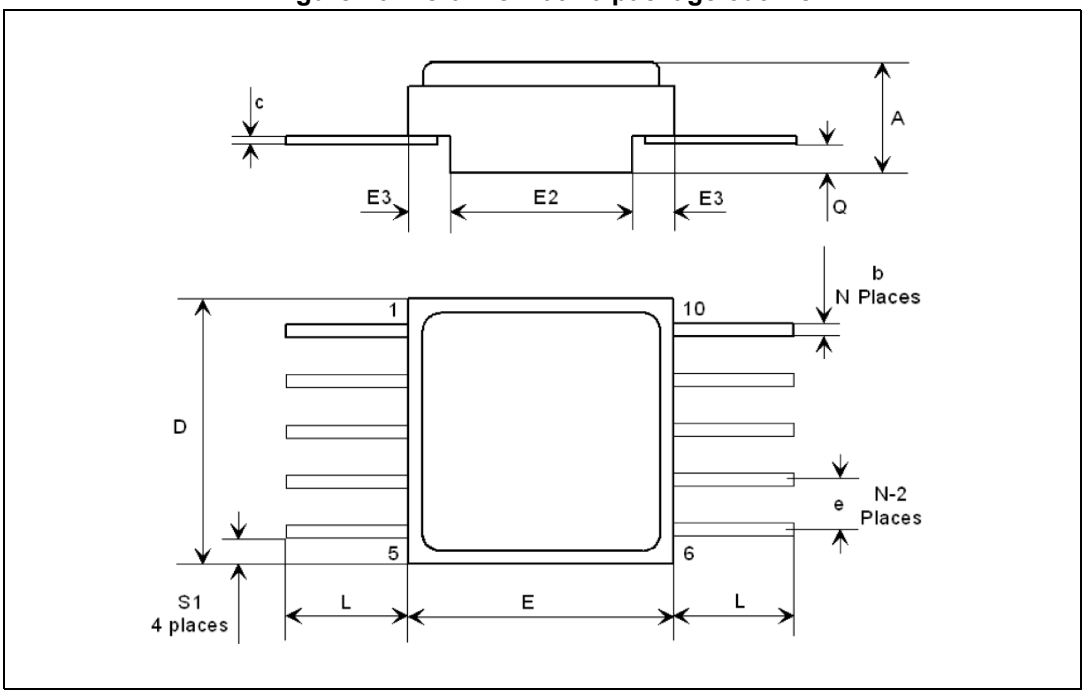



**Table 5. Ceramic Flat-10 mechanical data**

| Ref. | Dimensions | | | | | |
|---|---|---|---|---|---|---|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.26 | 2.44 | 2.62 | 0.089 | 0.096 | 0.103 |
| b | 0.38 | 0.43 | 0.48 | 0.015 | 0.017 | 0.019 |
| c | 0.102 | 0.127 | 0.152 | 0.004 | 0.005 | 0.006 |
| D | 6.35 | 6.48 | 6.60 | 0.250 | 0.255 | 0.260 |
| E | 6.35 | 6.48 | 6.60 | 0.250 | 0.255 | 0.260 |
| E2 | 4.32 | 4.45 | 4.58 | 0.170 | 0.175 | 0.180 |
| E3 | 0.88 | 1.01 | 1.14 | 0.035 | 0.040 | 0.045 |
| e | | 1.27 | | | 0.050 | |
| L | 6.35 | | 9.40 | 0.250 | | 0.370 |
| Q | 0.66 | 0.79 | 0.92 | 0.026 | 0.031 | 0.036 |
| S1 | 0.16 | 0.485 | 0.81 | 0.006 | 0.019 | 0.032 |
| N | 10 | | | 10 | | |

*Note:* The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package.

# 6 Ordering information

**Table 6. Order code**

| Order code | SMD (1) | Qualification level | Package | Lead finish | Marking (2) | Packing |
|---|---|---|---|---|---|---|
| RHF1009AK1 | - | Engineering Model | Flat-10 | Gold | RHF1009AK1 | Tray |
| RHF1009AK01V | 5962F14222 | QML-V Flight | | Gold | 5962F1422201VXC | |
| RHF1009AK02V | 5962F14222 | QML-V Flight | | Solder Dip | 5962F1422201VXA | |

1. Standard micro circuit drawing.
2. Specific marking only. Complete marking includes the following:

- ST logo
- Date code (date the package was sealed) in YYWWA (year, week, and lot index of week)
- Country of origin (FR = France)

# 7 Other information

## 7.1 Date code

The date code (date the package was sealed) is structured as follows:

- Engineering model: 3yywwz
- Flight model: yywwz

Where: yy = last two digits of the year, ww = week digits, z = lot index of the week

## 7.2 Product documentation

Each product shipment includes a set of associated documentation within the shipment box. This documentation depends on the quality level of the products, as detailed in the table below.

The certificate of conformance is provided on paper whatever the quality level. For QML parts, complete documentation, including the certificate of conformance, is provided on a CDROM.

**Table 7. Product documentation**

| Quality level | Item |
|---|---|
| Engineering model | Certificate of conformance including:<br>• Customer name<br>• Customer purchase order number<br>• ST sales order number and item<br>• ST part number<br>• Quantity delivered<br>• Date code<br>• Reference to ST datasheet<br>• Reference to TN1181 on engineering models<br>• ST Rennes assembly lot ID |
| QML-V Flight | Certificate of conformance including:<br>• Customer name<br>• Customer purchase order number<br>• ST sales order number and item<br>• ST part number<br>• Quantity delivered<br>• Date code<br>• Serial numbers<br>• Group C reference<br>• Group D reference<br>• Reference to the applicable SMD<br>• ST Rennes assembly lot ID |
| | Quality control inspection (groups A, B, C, D, E) |
| | Screening electrical data in/out summary |
| | Precap report |
| | PIND (particle impact noise detection) test |
| | SEM (scanning electronic microscope) inspection report |
| | X-ray plates |

# 8 Revision history

Table 8. Document revision history

| Date | Revision | Changes |
|---|---|---|
| 18-Jun-2014 | 1 | Initial release |
| 08-Jul-2015 | 2 | Features: updated Vref. accuracy<br>Table 3: Operating conditions: modified VKA<br>Corrected Figure 20: Spectral noise density vs. freq. at +25 °C, Ck = 1 µF and Figure 21: Spectral noise density vs. freq. at -55 °C, Ck = 100 nF.<br>Added Figure 23: Low freq. spectral noise density vs. freq. Ck = 100 nF to 1 µF, Ik = 60 µA to 10 mA.<br>Changed layout of Figure 24: Recommended operating area |
| 09-Apr-2018 | 3 | Updated the Description, Table 1: Device summary in cover page, Table 7: Order code and Table 8: Product documentation. |
| 17-Nov-2023 | 4 | Updated Section 4.4: Capacitive load considerations. |
| 28-Jan-2025 | 5 | Updated figure and features on the cover page, Section 6: Ordering information and Section 7: Other information. |
| 12-Sep-2025 | 6 | Added pin connections figure and new SMD: 5962F14222 feature on the cover page. |
| 07-Apr-2026 | 7 | Updated packing in *Table 6*. |

**IMPORTANT NOTICE – PLEASE READ CAREFULLY**

STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice.

In the event of any conflict between the provisions of this document and the provisions of any contractual arrangement in force between the purchasers and ST, the provisions of such contractual arrangement shall prevail.

The purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST’s terms and conditions of sale in place at the time of order acknowledgment.

The purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of the purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

If the purchasers identify an ST product that meets their functional and performance requirements but that is not designated for the purchasers' market segment, the purchasers shall contact ST for more information..

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to *www.st.com/trademarks*. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2026 STMicroelectronics – All rights reserved